

L Number	Hits	Search Text	DB	Time stamp
-	0	("6746502").PN.	USPAT	2003/08/10 21:56
-	1	("6476502").PN.	USPAT	2003/08/10 22:51
-	1	("5541450").PN.	USPAT	2003/08/10 22:52
-	594	257/778.ccls. and (dam or ring or frame)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2003/08/10 23:02
-	0	(257/778.ccls. and (dam or ring or frame)) and ((wetting or wet) adj angle)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2003/08/10 23:03
-	0	(257/778.ccls. and (dam or ring or frame)) and ((wetting or wet) near angle)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2003/08/10 23:03
-	1330	((wetting or wet) near angle)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2003/08/10 23:06
-	0	((257/778.ccls. and (dam or ring or frame)) and ((wetting or wet) near angle)) and (chip or die)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2003/08/10 23:04
-	193	((wetting or wet) near angle)) and (chip or die)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2003/08/10 23:04
-	5	((((wetting or wet) near angle)) and (chip or die)) and (encapsulate or encapsulant)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2003/08/10 23:04
-	0	((wetting or wet) near angle) with (resin or encapsulant or encapsulate or epoxy)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2003/08/10 23:06
-	541	(257/778.ccls. and (dam or ring or frame)) and (@ad<20011211)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2003/08/10 23:07
-	372	((257/778.ccls. and (dam or ring or frame)) and (@ad<20011211)) and (encapsulant or encapsulate or resin or epoxy)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2003/08/10 23:53
-	1	("20030038381").PN.	USPAT; US-PGPUB	2003/08/11 01:00
-	1	("5895965").PN.	USPAT; US-PGPUB	2003/08/11 01:05
-	0	("64752598").PN.	USPAT; US-PGPUB	2003/08/11 01:06
-	1	("6472598").PN.	USPAT; US-PGPUB	2003/08/11 01:07
-	1	("5450283").PN.	USPAT; US-PGPUB	2003/08/11 01:30

-	27	((encapsualnt or encapsulate) with affinity)	USPAT; US-PPGPUB; EPO; JPO; DERWENT; IBM TDB	2003/08/11 01:32
---	----	---	--	---------------------